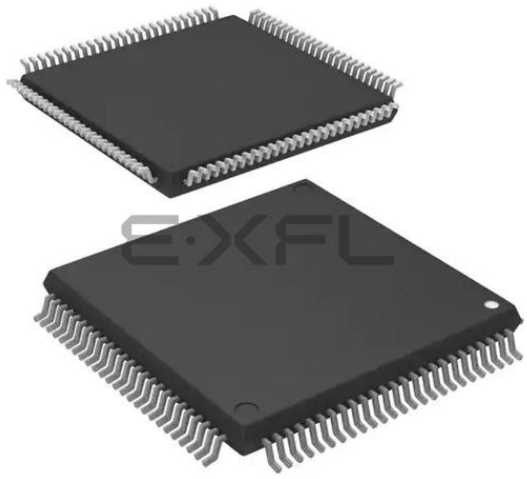
Renesas Electronics America Inc - R5F562TABDFP#V1 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, I²C, LINbus, SCI, SPI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	55
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 12x10b, 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f562tabdfp-v1

Table 1.5 List of Pins and Pin Functions (100-Pin LQFP) (2 / 3)

Pin No. (80-Pin LQFP)	Power Supply Clock System Control	I/O Port	Analog	Timer	Communi-cation	Interrupt	POE	Debugging
41		PA0		MTIOC6C	SSL3-B			
42	VCC							
43		P96				IRQ4	POE4#	
44	VSS							
45		P95		MTIOC6B				
46		P94		MTIOC7A				
47		P93		MTIOC7B				
48		P92		MTIOC6D				
49		P91		MTIOC7C				
50		P90		MTIOC7D				
51		P76		MTIOC4D/ GTIOC2B-A				
52		P75		MTIOC4C/ GTIOC1B-A				
53		P74		MTIOC3D/ GTIOC0B-A				
54		P73		MTIOC4B/ GTIOC2A-A				
55		P72		MTIOC4A/ GTIOC1A-A				
56		P71		MTIOC3B/ GTIOC0A-A				
57		P70				IRQ5	POE0#	
58		P33		MTIOC3A/ MTCLKA-A	SSL3-A			
59		P32		MTIOC3C/ MTCLKB-A	SSL2-A			
60	VCC							
61		P31		MTIOC0A-B/ MTCLKC-A	SSL1-A			
62	VSS							
63		P30		MTIOC0B-B/ MTCLKD-A	SSL0-A			
64		P24			RSPCK-A			
65		P23			CTX-B/ LTX/ MOSI-A			
66		P22	ADTRG#		CRX-B/ LRX/ MISO-A			
67		P21	ADTRG1#-B	MTCLKA-B		IRQ6		
68		P20	ADTRG0#-B	MTCLKB-B		IRQ7		
69		P65	AN5					
70		P64	AN4					
71	AVCC							
72	VREF							
73	AVSS							
74		P63	AN3					
75		P62	AN2					
76		P61	AN1					

Table 1.9 Pin Functions (4 / 4)

Classifications	Pin Name	I/O	Description
I/O ports	P10, P11	I/O	2-bit input/output pins.
	P20 to P24	I/O	5-bit input/output pins. The P20/P21 pin is not included in the 64-pin version.
	P30 to P33	I/O	4-bit input/output pins.
	P40 to P47	Input	8-bit input pins.
	P50 to P55	Input	6-bit input pins. Not included in the 80-/64-pin versions.
	P60 to P65	Input	6-bit input pins. The P64/P6 pin is not included in the 80-pin version. Not included in the 64-pin version.
	P70 to P76	I/O	7-bit input/output pins.
	P80 to P82	I/O	3-bit input/output pins. Not included in the 80-/64-pin versions.
	P90 to P96	I/O	7-bit input/output pins. The P90 pin is not included in the 80-pin version. The P90/P95/P96 pin is not included in the 64-pin version.
	PA0 to PA5	I/O	6-bit input/output pins. The PA0/PA1 pin is not included in the 80-/64-pin versions.
	PB0 to PB7	I/O	8-bit input/output pins.
	PD0 to PD7	I/O	8-bit input/output pins. The PD0/PD1/PD2 pin is not included in the 80-/64-pin versions.
	PE0, PE1, PE3 to PE5	I/O	5-bit input/output pins. The PE1/PE5 pin is not included in the 80-pin version. Not included in the 64-pin version.
	PE2	Input	1-bit input pin.
	PG0 to PG5	I/O	6-bit input/output pins. Not included in the 100-/80-/64-pin versions.

Note: • Which pins are and are not incorporated depends on the package.
For details, see the list of pins and pin functions in Table 1.4 to Table 1.8.

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

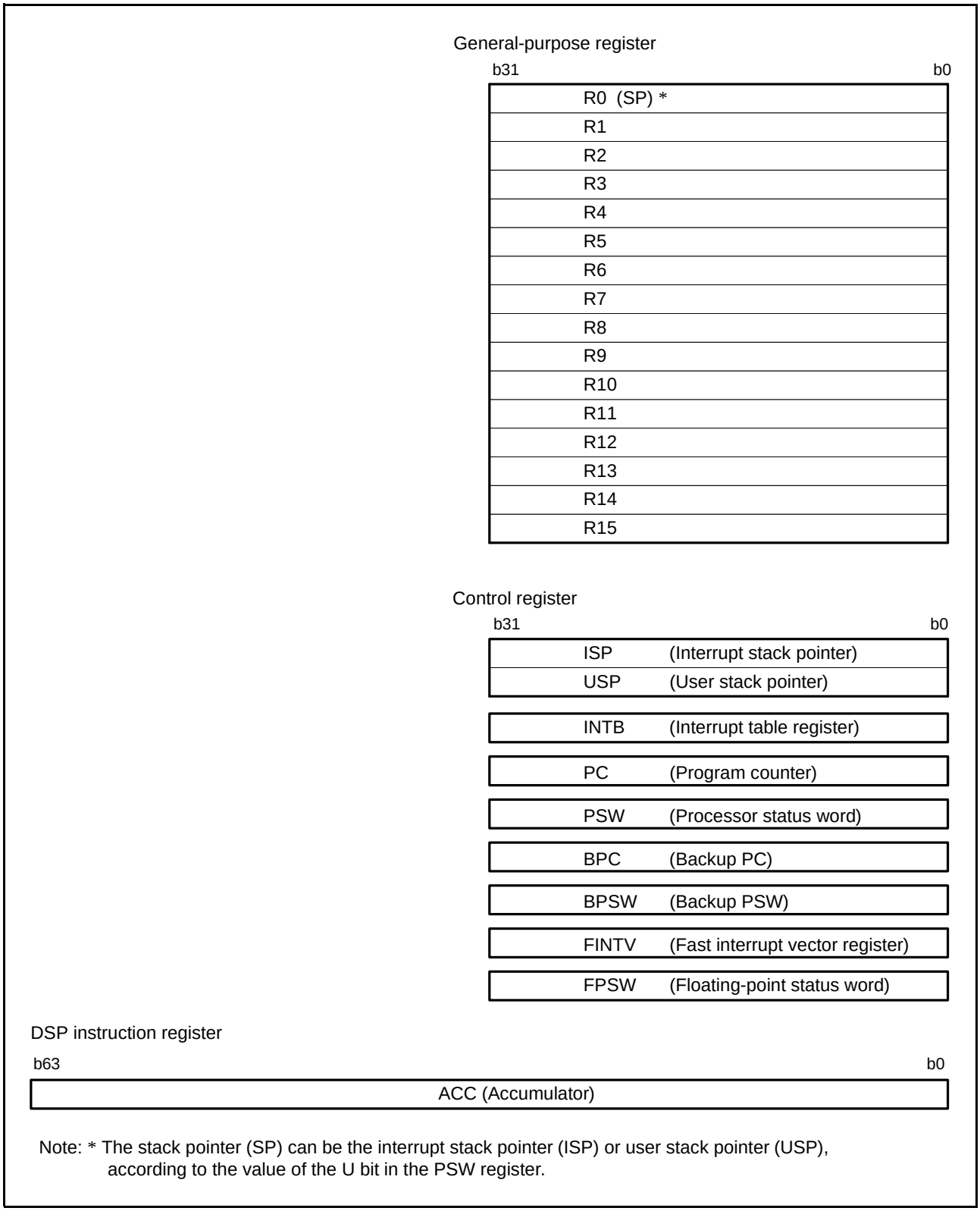


Figure 2.1 Register Set of the CPU

2.1 General-Purpose Registers (R0 to R15)

This CPU has sixteen general-purpose registers (R0 to R15). R1 to R15 can be used as data registers or address registers. R0, a general-purpose register, also functions as the stack pointer (SP). The stack pointer is switched to operate as the interrupt stack pointer (ISP) or user stack pointer (USP) by the value of the stack pointer select bit (U) in the processor status word (PSW).

2.2 Control Registers

(1) Interrupt Stack Pointer (ISP)/User Stack Pointer (USP)

The stack pointer (SP) can be either of two types, the interrupt stack pointer (ISP) or the user stack pointer (USP). Whether the stack pointer operates as the ISP or USP depends on the value of the stack pointer select bit (U) in the processor status word (PSW).
Set the ISP or USP to a multiple of four, as this reduces the numbers of cycles required to execute interrupt sequences and instructions entailing stack manipulation.

(2) Interrupt Table Register (INTB)

The interrupt table register (INTB) specifies the address where the relocatable vector table starts.
Set INTB to a multiple of four.

(3) Program Counter (PC)

The program counter (PC) indicates the address of the instruction being executed.

(4) Processor Status Word (PSW)

The processor status word (PSW) indicates results of instruction execution or the state of the CPU.

(5) Backup PC (BPC)

The backup PC (BPC) is provided to speed up response to interrupts.
After a fast interrupt has been generated, the contents of the program counter (PC) are saved in the BPC.

(6) Backup PSW (BPSW)

The backup PSW (BPSW) is provided to speed up response to interrupts.
After a fast interrupt has been generated, the contents of the processor status word (PSW) are saved in the BPSW. The allocation of bits in the BPSW corresponds to that in the PSW.

(7) Fast Interrupt Vector Register (FINTV)

The fast interrupt vector register (FINTV) is provided to speed up response to interrupts.
The FINTV register specifies a branch destination address when a fast interrupt has been generated.

(8) Floating-Point Status Word (FPSW)

The floating-point status word (FPSW) indicates the results of floating-point operations.
When an exception handling enable bit (Ej) enables the exception handling (Ej = 1), the exception cause can be identified by checking the corresponding Cj flag in the exception handling routine. If the exception handling is masked (Ej = 0), the occurrence of exception can be checked by reading the Fj flag at the end of a series of processing. Once the Fj flag has been set to 1, this value is retained until it is cleared to 0 by software (j = X, U, Z, O, or V).

Table 4.1 List of I/O Registers (Address Order) (2 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
0008 6526h	MPU	Region invalidation operation register	MPOPI	16	16	1 ICLK
0008 6528h	MPU	Instruction-hit region register	MHITI	32	32	1 ICLK
0008 652Ch	MPU	Data-hit region register	MHITD	32	32	1 ICLK
0008 7010h	ICU	Interrupt request register 016	IR016	8	8	2 ICLK
0008 7015h	ICU	Interrupt request register 021	IR021	8	8	2 ICLK
0008 7017h	ICU	Interrupt request register 023	IR023	8	8	2 ICLK
0008 701Bh	ICU	Interrupt request register 027	IR027	8	8	2 ICLK
0008 701Ch	ICU	Interrupt request register 028	IR028	8	8	2 ICLK
0008 701Dh	ICU	Interrupt request register 029	IR029	8	8	2 ICLK
0008 701Eh	ICU	Interrupt request register 030	IR030	8	8	2 ICLK
0008 701Fh	ICU	Interrupt request register 031	IR031	8	8	2 ICLK
0008 702Ch	ICU	Interrupt request register 044	IR044	8	8	2 ICLK
0008 702Dh	ICU	Interrupt request register 045	IR045	8	8	2 ICLK
0008 702Eh	ICU	Interrupt request register 046	IR046	8	8	2 ICLK
0008 702Fh	ICU	Interrupt request register 047	IR047	8	8	2 ICLK
0008 7038h	ICU	Interrupt request register 056	IR056	8	8	2 ICLK
0008 7039h	ICU	Interrupt request register 057	IR057	8	8	2 ICLK
0008 703Ah	ICU	Interrupt request register 058	IR058	8	8	2 ICLK
0008 703Bh	ICU	Interrupt request register 059	IR059	8	8	2 ICLK
0008 703Ch	ICU	Interrupt request register 060	IR060	8	8	2 ICLK
0008 7040h	ICU	Interrupt request register 064	IR064	8	8	2 ICLK
0008 7041h	ICU	Interrupt request register 065	IR065	8	8	2 ICLK
0008 7042h	ICU	Interrupt request register 066	IR066	8	8	2 ICLK
0008 7043h	ICU	Interrupt request register 067	IR067	8	8	2 ICLK
0008 7044h	ICU	Interrupt request register 068	IR068	8	8	2 ICLK
0008 7045h	ICU	Interrupt request register 069	IR069	8	8	2 ICLK
0008 7046h	ICU	Interrupt request register 070	IR070	8	8	2 ICLK
0008 7047h	ICU	Interrupt request register 071	IR071	8	8	2 ICLK
0008 7060h	ICU	Interrupt request register 096	IR096	8	8	2 ICLK
0008 7062h	ICU	Interrupt request register 098	IR098	8	8	2 ICLK
0008 7066h	ICU	Interrupt request register 102	IR102	8	8	2 ICLK
0008 7067h	ICU	Interrupt request register 103	IR103	8	8	2 ICLK
0008 706Ah	ICU	Interrupt request register 106	IR106	8	8	2 ICLK
0008 7072h	ICU	Interrupt request register 114	IR114	8	8	2 ICLK
0008 7073h	ICU	Interrupt request register 115	IR115	8	8	2 ICLK
0008 7074h	ICU	Interrupt request register 116	IR116	8	8	2 ICLK
0008 7075h	ICU	Interrupt request register 117	IR117	8	8	2 ICLK
0008 7076h	ICU	Interrupt request register 118	IR118	8	8	2 ICLK
0008 7077h	ICU	Interrupt request register 119	IR119	8	8	2 ICLK
0008 7078h	ICU	Interrupt request register 120	IR120	8	8	2 ICLK
0008 7079h	ICU	Interrupt request register 121	IR121	8	8	2 ICLK
0008 707Ah	ICU	Interrupt request register 122	IR122	8	8	2 ICLK
0008 707Bh	ICU	Interrupt request register 123	IR123	8	8	2 ICLK
0008 707Ch	ICU	Interrupt request register 124	IR124	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (17 / 25)

Address	Module Abbreviation	Register Name	Register Abbreviation	Number of Bits	Access Size	Number of Access Cycles
000C 123Ah	MTU	Timer interrupt skipping mode register A	TITMRA	8	8	5 ICLK
000C 123Bh	MTU	Timer interrupt skipping set register 2A	TITCR2A	8	8	5 ICLK
000C 123Ch	MTU	Timer interrupt skipping counter 2A	TITCNT2A	8	8	5 ICLK
000C 1240h	MTU4	Timer A/D converter start request control register	TADCR	16	16	5 ICLK
000C 1244h	MTU4	Timer A/D converter start request cycle set register A	TADCORA	16	16, 32	5 ICLK
000C 1246h	MTU4	Timer A/D converter start request cycle set register B	TADCORB	16	16	5 ICLK
000C 1248h	MTU4	Timer A/D converter start request cycle set buffer register A	TADCOBRA	16	16, 32	5 ICLK
000C 124Ah	MTU4	Timer A/D converter start request cycle set buffer register B	TADCOBRB	16	16	5 ICLK
000C 1260h	MTU	Timer waveform control register A	TWCRA	8	8	5 ICLK
000C 1270h	MTU3	Timer mode register 2A	TMDR2A	8	8	5 ICLK
000C 1272h	MTU3	Timer general register E	TGRE	16	16	5 ICLK
000C 1274h	MTU4	Timer general register E	TGRE	16	16	5 ICLK
000C 1276h	MTU4	Timer general register F	TGRF	16	16	5 ICLK
000C 1280h	MTU	Timer start register A	TSTRA	8	8, 16	5 ICLK
000C 1281h	MTU	Timer synchronous register A	TSYRA	8	8	5 ICLK
000C 1282h	MTU	Timer counter synchronous start register	TCSYSTR	8	8	5 ICLK
000C 1284h	MTU	Timer read/write enable register A	TRWERA	8	8	5 ICLK
000C 1300h	MTU0	Timer control register	TCR	8	8, 16, 32	5 ICLK
000C 1301h	MTU0	Timer mode register 1	TMDR1	8	8	5 ICLK
000C 1302h	MTU0	Timer I/O control register H	TIORH	8	8, 16	5 ICLK
000C 1303h	MTU0	Timer I/O control register L	TIORL	8	8	5 ICLK
000C 1304h	MTU0	Timer interrupt enable register	TIER	8	8, 16, 32	5 ICLK
000C 1305h	MTU0	Timer status register	TSR	8	8	5 ICLK
000C 1306h	MTU0	Timer counter	TCNT	16	16	5 ICLK
000C 1308h	MTU0	Timer general register A	TGRA	16	16, 32	5 ICLK
000C 130Ah	MTU0	Timer general register B	TGRB	16	16	5 ICLK
000C 130Ch	MTU0	Timer general register C	TGRC	16	16, 32	5 ICLK
000C 130Eh	MTU0	Timer general register D	TGRD	16	16	5 ICLK
000C 1320h	MTU0	Timer general register E	TGRE	16	16, 32	5 ICLK
000C 1322h	MTU0	Timer general register F	TGRF	16	16	5 ICLK
000C 1324h	MTU0	Timer interrupt enable register 2	TIER2	8	8, 16	5 ICLK
000C 1325h	MTU0	Timer status register 2	TSR2	8	8	5 ICLK
000C 1326h	MTU0	Timer buffer operation transfer mode register	TBTM	8	8	5 ICLK
000C 1380h	MTU1	Timer control register	TCR	8	8, 16	5 ICLK
000C 1381h	MTU1	Timer mode register 1	TMDR1	8	8	5 ICLK
000C 1382h	MTU1	Timer I/O control register	TIOR	8	8	5 ICLK
000C 1384h	MTU1	Timer interrupt enable register	TIER	8	8, 16, 32	5 ICLK
000C 1385h	MTU1	Timer status register	TSR	8	8	5 ICLK
000C 1386h	MTU1	Timer counter	TCNT	16	16	5 ICLK
000C 1388h	MTU1	Timer general register A	TGRA	16	16, 32	5 ICLK
000C 138Ah	MTU1	Timer general register B	TGRB	16	16	5 ICLK

Table 4.2 List of I/O Registers (Bit Order) (15 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
SYSTEM	DPSIFR	DNMIF	—	—	DLVDF	—	—	DIRQ1F	DIRQ0F
SYSTEM	DPSIEGR	DNMIEG	—	—	—	—	—	DIRQ1EG	DIRQ0EG
SYSTEM	RSTSR	DPSRSTF	—	—	—	—	LVD2F	LVD1F	PORF
FLASH	FWEPROR	—	—	—	—	—	—	FLWE[1:0]	
SYSTEM	LVDKEYR	KEY[7:0]							
SYSTEM	LVDCR	LVD2E	LVD2RI	—	—	LVD1E	LVD1RI	—	—
SYSTEM	DPSBKR0								
SYSTEM	DPSBKR1								
SYSTEM	DPSBKR2								
SYSTEM	DPSBKR3								
SYSTEM	DPSBKR4								
SYSTEM	DPSBKR5								
SYSTEM	DPSBKR6								
SYSTEM	DPSBKR7								
SYSTEM	DPSBKR8								
SYSTEM	DPSBKR9								
SYSTEM	DPSBKR10								
SYSTEM	DPSBKR11								
SYSTEM	DPSBKR12								
SYSTEM	DPSBKR13								
SYSTEM	DPSBKR14								
SYSTEM	DPSBKR15								
SYSTEM	DPSBKR16								
SYSTEM	DPSBKR17								
SYSTEM	DPSBKR18								
SYSTEM	DPSBKR19								
SYSTEM	DPSBKR20								
SYSTEM	DPSBKR21								
SYSTEM	DPSBKR22								
SYSTEM	DPSBKR23								
SYSTEM	DPSBKR24								
SYSTEM	DPSBKR25								
SYSTEM	DPSBKR26								
SYSTEM	DPSBKR27								
SYSTEM	DPSBKR28								
SYSTEM	DPSBKR29								
SYSTEM	DPSBKR30								
SYSTEM	DPSBKR31								
POE	ICSR1	—	—	—	POE0F	—	—	—	PIE1
		—	—	—	—	—	—	POE0M[1:0]	
POE	OCSR1	OSF1	—	—	—	—	—	OCE1	OIE1
		—	—	—	—	—	—	—	—
POE	ICSR2	—	—	—	POE4F	—	—	—	PIE2
		—	—	—	—	—	—	POE4M[1:0]	
POE	OCSR2	OSF2	—	—	—	—	—	OCE2	OIE2
		—	—	—	—	—	—	—	—
POE	ICSR3	—	—	—	POE8F	—	—	POE8E	PIE3
		—	—	—	—	—	—	POE8M[1:0]	
POE	SPOER	—	—	—	GPT23HIZ	GPT01HIZ	MTUCH0HIZ	MTUCH67HIZ	MTUCH34HIZ
POE	POECR1	—	—	—	—	MTU0DZE	MTU0CZE	MTU0BZE	MTU0AZE

Table 4.2 List of I/O Registers (Bit Order) (19 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
MTU3	TGRA								
MTU3	TGRB								
MTU4	TGRA								
MTU4	TGRB								
MTU	TCNTSA								
MTU	TCBRA								
MTU3	TGRC								
MTU3	TGRD								
MTU4	TGRC								
MTU4	TGRD								
MTU3	TSR	TCFD	—	—	TCFV	TGFD	TGFC	TGFB	TGFA
MTU4	TSR	TCFD	—	—	TCFV	TGFD	TGFC	TGFB	TGFA
MTU	TITCR1A	T3AEN		T3ACOR[2:0]		T4VEN		T4VCOR[2:0]	
MTU	TBTERA	—		T3ACOR[2:0]		—		T4VCNT[2:0]]	
MTU	TBTERA	—	—	—	—	—	—	BTE[1:0]	
MTU	TDERA	—	—	—	—	—	—	—	TDER
MTU	TOLBRA	—	—	OLS3N	OLS3P	OLS2N	OLS2P	OLS1N	OLS1P
MTU3	TBTM	—	—	—	—	—	—	TTSB	TTSA
MTU4	TBTM	—	—	—	—	—	—	TTSB	TTSA
MTU	TITMRA	—	—	—	—	—	—	—	TITM
MTU	TITCR2A	—	—	—	—	—		TRG4COR[2:0]	
MTU	TITCNT2A	—	—	—	—	—		TRG4COR[2:0]	
MTU4	TADCR	BF[1:0]		—	—	—	—	—	—
		UT4AE	DT4AE	UT4BE	DT4BE	ITA3AE	ITA4VE	ITB3AE	ITB4VE
MTU4	TADCORA								
MTU4	TADCORB								
MTU4	TADCOBRA								
MTU4	TADCOBRB								
MTU	TWCRA	CCE	—	—	—	—	—	—	WRE
MTU	TMDR2A	—	—	—	—	—	—	—	DRS
MTU3	TGRE								
MTU4	TGRE								
MTU4	TGRF								
MTU	TSTRA	CST4	CST3	—	—	—	CST2	CST1	CST0
MTU	TSYRA	SYNC4	SYNC3	—	—	—	SYNC2	SYNC1	SYNC0
MTU	TCSYSTR	SCH0	SCH1	SCH2	SCH3	SCH4	—	SCH6	SCH7
MTU	TRWERA	—	—	—	—	—	—	—	RWE
MTU0	TCR		CCLR[2:0]			CKEG[1:0]		TPSC[2:0]	

Table 4.2 List of I/O Registers (Bit Order) (30 / 30)

Module Abbreviation	Register Abbreviation	Bit 31/23/15/7	Bit 30/22/14/6	Bit 29/21/13/5	Bit 28/20/12/4	Bit 27/19/11/3	Bit 26/18/10/2	Bit 25/17/9/1	Bit 24/16/8/0
FLASH	FSTATR0	FRDY	ILGLERR	ERSERR	PRGERR	SUSRDY	—	ERSSPD	PRGSPD
FLASH	FSTATR1	FCUERR	—	—	FLOCKST	—	—	—	—
FLASH	FENTRYR	FEKEY[7:0]							
		FENTRYD	—	—	—	—	—	—	FENTRY0
FLASH	FPROTR	FPKEY[7:0]							
		—	—	—	—	—	—	—	FPROTCN
FLASH	FRESETR	FRKEY[7:0]							
		—	—	—	—	—	—	—	FRESET
FLASH	FCMDR	CMDR[7:0]							
		PCMDR[7:0]							
FLASH	FCPSR	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	ESUSPMD
FLASH	DFLBCCNT	—	—	—	—	—		BCADR[7:0]	
		BCADR[7:0]						—	BCSIZE
FLASH	FPESTAT	—	—	—	—	—	—	—	—
		PEERRST[7:0]							
FLASH	DFLBCSTAT	—	—	—	—	—	—	—	—
		—	—	—	—	—	—	—	BCST
FLASH	PCKAR	—	—	—	—	—	—	—	—
		PCKA[7:0]							

Note: • In this, the I/O port related registers (0008 C001h to 0008 C116h) indicate the bit configuration of the 112-pin LQFP version. As the configuration of registers and bits differs depending on a package, see section 14, I/O Ports, for details in the User's manual: Hardware.

Note 1. This shows the bit configuration when ADDPR.DPSEL = 0 and ADDPR.DPPRC = 0 (The value has 10-bit accuracy and is padded at the LSB end).

Note 2. This shows the bit configuration when ADCER.ADRFMT = 0 (aligned to the LSB end) and ADCER.ADPRC[1:0] = 00b. For details, refer to section 28, 12-Bit A/D Converter (S12ADA) in the User's manual: Hardware.

Note 3. This function is not supported by the product without the CAN function.

Table 5.2 DC Characteristics (1) (3 / 3)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input capacitance	All input pins (except for ports PB1 and PB2)	C_{in}	-	-	15	pF	V_{in} = 0 V, f = 1 MHz, T_a = 25°C
	Ports PB1 and PB2		-	-	30		

Note 1. This includes the multiplexed input pins, except in cases where port pins PB1 and PB2 are used as RIIC input pins or port pins P22 to P24, P30, PA3 to PA5, PB0, PD0 to PD2, or PD6 are used as RSPI input pins.

Table 5.4 Permissible Output Currents

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Typ.	Max.	Unit
Permissible output low current (average value per pin)	I_{OL}	-	-	2.0*1	mA
Permissible output low current (max. value per pin)	I_{OL}	-	-	4.0*1	mA
Permissible output low current (total)	ΣI_{OL}	-	-	110	mA
Permissible output high current (average value per pin)	$-I_{OH}$	-	-	2.0*1	mA
Permissible output high current (max. value per pin)	$-I_{OH}$	-	-	4.0*1	mA
Permissible output high current (total)	$\Sigma -I_{OH}$	-	-	35	mA

Caution: To protect the LSI's reliability, the output current values should not exceed the permissible output current.

Note 1. I_{OL} = 15 mA (max.)/ $-I_{OH}$ = 5 mA (max.) for P71 to P76 and P90 to P95. Note, however, that up to 6 (112-pin or 100-pin LQFP) or 3 (80-pin or 64-pin LQFP) pins can accept over 2.0-mA I_{OL} / $-I_{OH}$ at the same time.

Table 5.5 Permissible Power Consumption (Only for G Version)

Note: Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Typ.	Max.	Unit	Test Conditions
Total permissible power consumption*1	Pd	—	325	mW	85°C < Ta ≤ 105°C

Note: • Please contact Renesas Electronics sales office for derating of operation under Ta = +85°C to +105°C. Derating is the systematic reduction of load for improved reliability.

Note 1. The total power consmuption of the whole chip including output current.

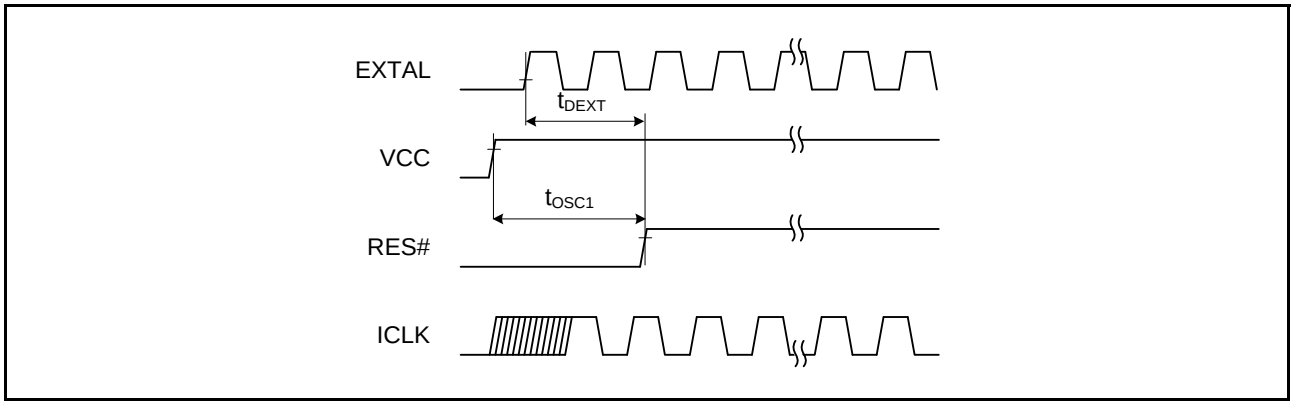


Figure 5.1 Oscillation Settling Timing

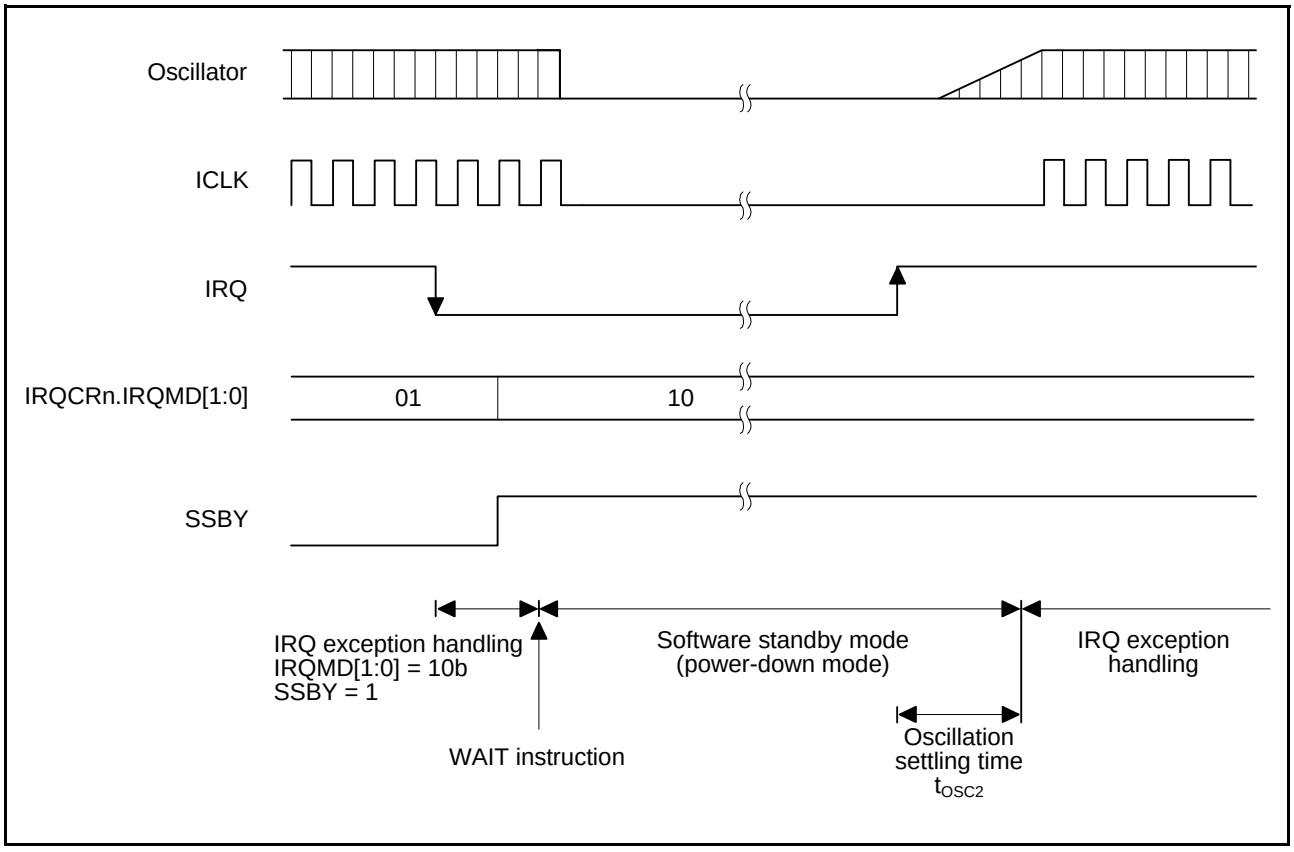


Figure 5.2 Oscillation Settling Timing after Software Standby Mode

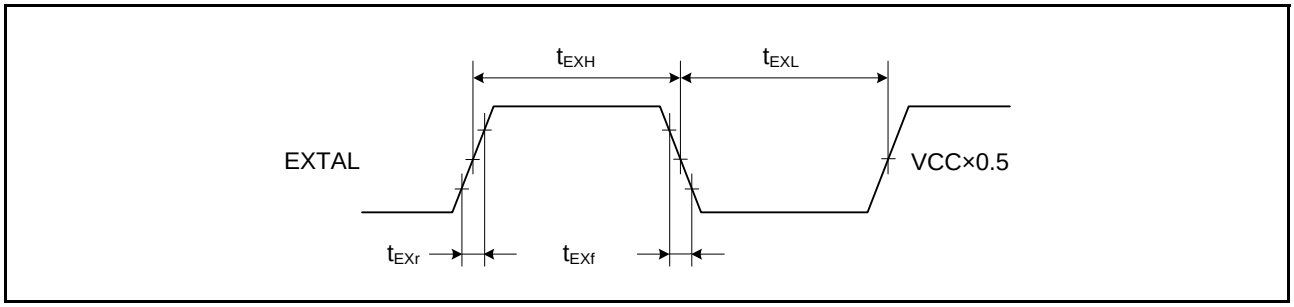


Figure 5.4 EXTAL External Input Clock Timing

5.3.2 Control Signal Timing

Table 5.8 Control Signal Timing

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item	Symbol	Min.	Max.	Unit	Test Conditions
RES# pulse width (except for programming or erasure of the ROM or data-flash memory or blank checking of the data-flash memory*1)	t_{RESW}*2	20	-	t_{Icyc}*4	Figure 5.5
		1.5	-	µs	
Internal reset time*3	t_{RESW2}	35	-	µs	
NMI pulse width	t_{NMIW}	200	-	ns	Figure 5.6
IRQ pulse width	t_{IRQW}	200	-	ns	Figure 5.7

Note 1. For a reset by the signal on the RES# pin during programming or erasure of the ROM or data-flash memory or during blank checking of the data-flash memory, see section 31.12, Usage Notes in section 31, ROM (Flash Memory for Code Storage) in the User's manual: Hardware.
Note 2. Both the time and the number of cycles should satisfy the specifications.
Note 3. This is to specify the FCU reset.
Note 4. ICLK cycles.

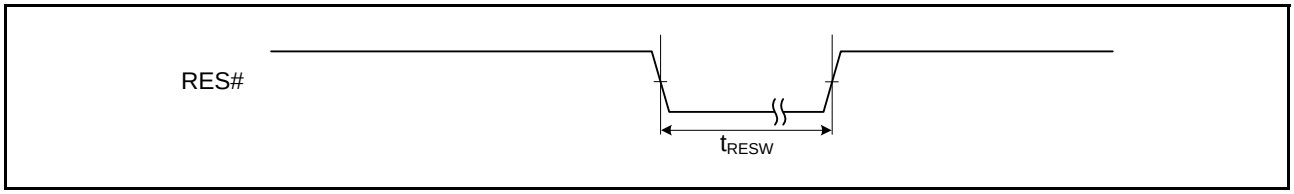


Figure 5.5 Reset Input Timing

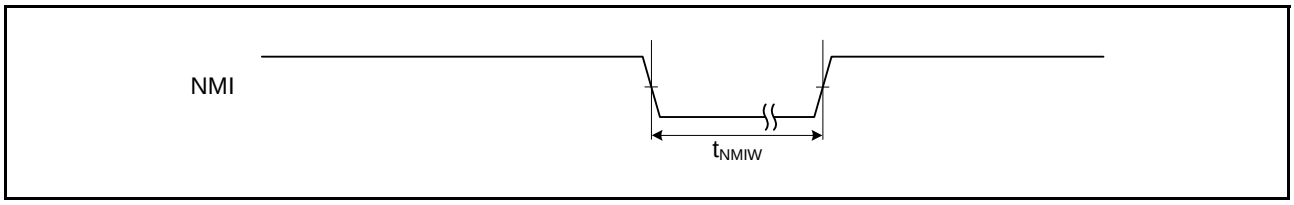


Figure 5.6 NMI Interrupt Input Timing

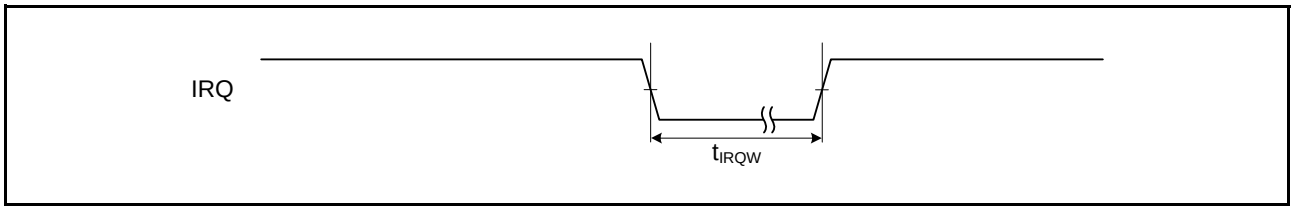


Figure 5.7 IRQ Interrupt Input Timing

Table 5.10 Timing of On-Chip Peripheral Modules (2)

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 1 to 3.

Item		Symbol	Min.*1 *2	Max.	Unit	Test Conditions
RIIC (standard mode)	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 1300	-	ns	Figure 5.10
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	-	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 1000	-	ns	
	SCL, SDA input rising time	t_{Sr}	-	1000	ns	
	SCL, SDA input falling time	t_{Sf}	-	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	-	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	-	ns	
	Re-start condition input setup time	t_{STAS}	1000	-	ns	
	Stop condition input setup time	t_{STOS}	1000	-	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	-	ns	
	Data input hold time	t_{SDAH}	0	-	ns	
	SCL, SDA capacitive load	C_b	-	400	pF	
RIIC (fast mode)	SCL input cycle time	t_{SCL}	6(12) × t_{IICcyc} + 600	-	ns	
	SCL input high pulse width	t_{SCLH}	3(6) × t_{IICcyc} + 300	-	ns	
	SCL input low pulse width	t_{SCLL}	3(6) × t_{IICcyc} + 300	-	ns	
	SCL, SDA input rising time	t_{Sr}	20 + 0.1C_b	300	ns	
	SCL, SDA input falling time	t_{Sf}	20 + 0.1C_b	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	1(4) × t_{IICcyc}	ns	
	SDA input bus free time	t_{BUF}	3(6) × t_{IICcyc} + 300	-	ns	
	Start condition input hold time	t_{STAH}	t_{IICcyc} + 300	-	ns	
	Re-start condition input setup time	t_{STAS}	300	-	ns	
	Stop condition input setup time	t_{STOS}	300	-	ns	
	Data input setup time	t_{SDAS}	t_{IICcyc} + 50	-	ns	
	Data input hold time	t_{SDAH}	0	-	ns	
	SCL, SDA capacitive load	C_b	-	400	pF	

Note: • t_{IICcyc}: Cycles of internal base clock (IICφ) for the RIIC module
Note 1. The value in parentheses is used when ICMR3.NF[1:0] are set to 11b while a digital filter is enabled with ICFER.NFE = 1.
Note 2. Cb indicates the total capacity of the bus line.

5.4 A/D Conversion Characteristics

Table 5.15 10-Bit A/D Conversion Characteristics

Note:Items for which test conditions are not specifically stated in the table below have the same values under conditions 1 to 3.

Condition 1: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC
Ta = Topr

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time*1 (AD clock = 25-MHz operation)	2.0	-	-	μs	Sampling 25 states
Analog input capacitance	-	-	4	pF	
Integral nonlinearity error	-	-	±3.0	LSB	
Offset error	-	-	±3.0	LSB	
Full-scale error	-	-	±3.0	LSB	
Quantization error	-	±0.5	-	LSB	
Absolute accuracy	-	-	±4.0	LSB	
Permissible signal source impedance	-	-	1.0	kΩ	

Condition 2: VCC = PLLVCC = 2.7 to 3.6 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VSS = PLLVSS = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC
Ta = Topr. Ta is the same under conditions 2 and 3.

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	10	10	10	Bit	
Conversion time*1 (AD clock = 50-MHz operation)	1.0	-	-	μs	Sampling 25 states
Analog input capacitance	-	-	4	pF	
Integral nonlinearity error	-	-	±3.0	LSB	
Offset error	-	-	±3.0	LSB	
Full-scale error	-	-	±3.0	LSB	
Quantization error	-	±0.5	-	LSB	
Absolute accuracy	-	-	±4.0	LSB	
Permissible signal source impedance	-	-	1.0	kΩ	

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

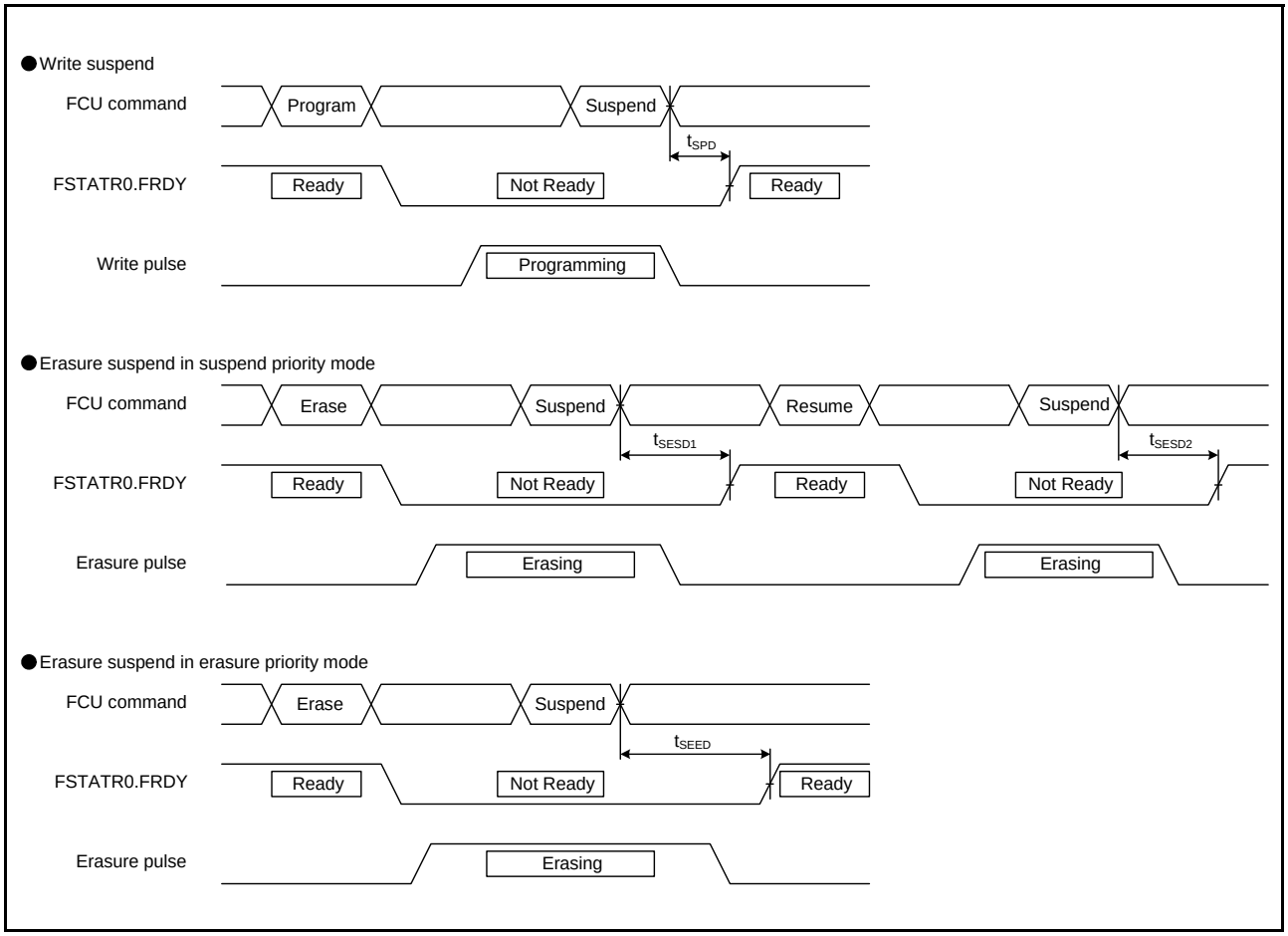
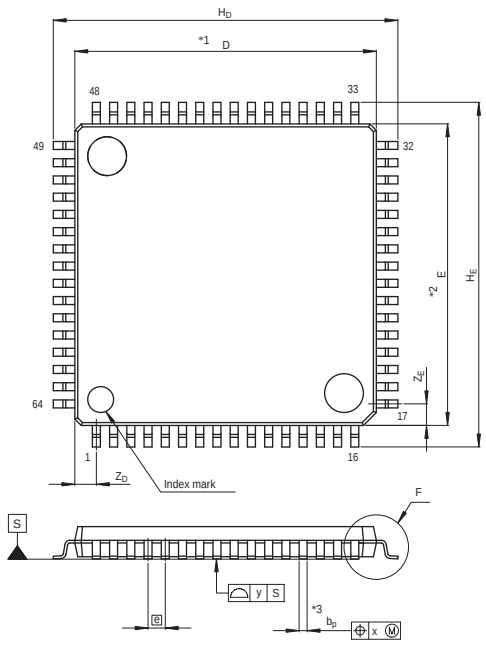
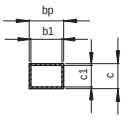


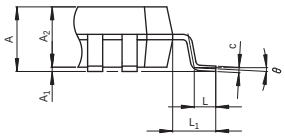
Figure 5.24 Flash Memory Write/Erase Suspend Timing

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-LQFP64-14x14-0.80	PLQP0064GA-A	64P6U-A/ —	0.7g





Terminal cross section



Detail F

NOTE)
1. DIMENSIONS "*1" AND "*2" DO NOT INCLUDE MOLD FLASH.
2. DIMENSION "*3" DOES NOT INCLUDE TRIM OFFSET.

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	13.9	14.0	14.1
E	13.9	14.0	14.1
A_2	—	1.4	—
H_D	15.8	16.0	16.2
H_E	15.8	16.0	16.2
A	—	—	1.7
A_1	0	0.1	0.2
b_p	0.32	0.37	0.42
b_1	—	0.35	—
c	0.09	0.145	0.20
c_1	—	0.125	—
θ	0°	—	8°
e	—	0.8	—
x	—	—	0.20
y	—	—	0.10
Z_D	—	1.0	—
Z_E	—	1.0	—
L	0.3	0.5	0.7
L_1	—	1.0	—

Figure E 64-Pin LQFP (PLQP0064GA-A) Package Dimensions

REVISION HISTORY — RX62T Group, RX62G Group Datasheet

Rev.	Date	Description	
		Page	Summary
1.00	Apr 20, 2011	—	First edition issued
1.30	May 22, 2013	1	Features, Package lineup, added
			1. Overview
		2	Table 1.1 Outline of Specifications (1/5) Description of CPU, added
		3	Table 1.1 Outline of Specifications (2/5) Description of Programmable I/O ports, changed
		6	Table 1.1 Outline of Specifications (5/5), 64-pin packaged, added
		7	Table 1.2 Functions of RX62T Group Products, 64-pin package, and MTU3/GPT complementary PWM pins added
		8	Table 1.3 List of Products, 64-pin package part number, changed
		9	Figure 1.1 How to Read the Product Part No., 64-pin package part number, changed
		9	Figure 1.1 How to Read the Product Part No., 5-V version, two-motor control supported, added
		10	Figure 1.2 Block Diagram, changed
		14	Figure 1.6 Pin Assignment of the 80-Pin LQFP (Two-motor Control Supported), added
		15	Figure 1.7 Pin Assignment of the 64-Pin LQFP, Figure PLQP0064GA-A, added
		25 to 27	Table 1.7 List of Pins and Pin Functions (80-Pin LQFP: R5F562TxGDFF) , added
		30 to 33	Table 1.9 Pin Functions, changed
			4. I/O Register
		38to 61	Table 4.1 List of I/O Registers (Address Order), MPU, added
		47	Table 4.1 List of I/O Registers (Address Order) TMOCNTL, TMOCNTU register, added
		57	Table 4.1 List of I/O Registers (Address Order), GTSWP register, added
			5. Electrical Characteristics
		62	Table 5.1 Absolute Maximum Ratings, note changed
		64	Table 5.2 DC Characteristics (1) (2/3) Test Conditions of P90 to P95, changed
		66	Table 5.3 DC Characteristics (2), note changed
		67	Table 5.4 Permissible Output Currents, note changed
		72	Table 5.7 Control Signal Timing, notes changed
		73	Table 5.8 Timing of On-Chip Peripheral Modules (1), changed
			Appendix 1.Package Dimensions
		96	Figure E 64-Pin LQFP (PLQP0064GA-A), added
2.00	Jan 10, 2014	1	Features, changed
			1. Overview
		2 to 6	Table 1.1 Outline of Specifications, changed; Note 1, added
		7, 8	Table 1.2 Functions of RX62T Group and RX62G Group Products, changed
		9, 10	Table 1.3 List of Products, changed; Note 1, added
		11	Figure 1.1 How to Read the Product Part No., changed
		15	Figure 1.6 Pin Assignment of the 80-Pin LQFP (Two-Motor Control Supported Version), added
		27 to 29	Table 1.7 List of Pins and Pin Functions (80-Pin LQFP: R5F562TxGDFF), added
			4. I/O Registers
		43 to 67	Table 4.1 List of I/O Registers (Address Order), changed
		68 to 97	Table 4.2 List of I/O Registers (Bit Order), changed
			5. Electrical Characteristics
		—	Conditions in the table, change to Ta = -40 to +105°C from Ta = -40 to +85°C.

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